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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "<u>Embedded - Microcontrollers</u>"

Details	
Product Status	Not For New Designs
Core Processor	R8C
Core Size	16-Bit
Speed	20MHz
Connectivity	I ² C, LINbus, SIO, SSU, UART/USART
Peripherals	LED, POR, Voltage Detect, WDT
Number of I/O	25
Program Memory Size	32KB (32K x 8)
Program Memory Type	FLASH
EEPROM Size	2K x 8
RAM Size	1.5K x 8
Voltage - Supply (Vcc/Vdd)	2.2V ~ 5.5V
Data Converters	A/D 12x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	32-LQFP
Supplier Device Package	32-LQFP (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f21276sdfp-x6

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

1.2 Performance Overview

Table 1.1 outlines the Functions and Specifications for R8C/26 Group and Table 1.2 outlines the Functions and Specifications for R8C/27 Group.

Table 1.1 Functions and Specifications for R8C/26 Group

ODLI	Item	Specification
CPU	Number of	89 instructions
	fundamental	
	instructions Minimum instruction	50 ns (f(XIN) = 20 MHz, VCC = 3.0 to 5.5 V) (other than K version)
	execution time	62.5 ns (f(XIN) = 20 MHz, VCC = 3.0 to 5.5 V) (MINER THAIL K VERSION)
	execution time	100 ns (f(XIN) = 10 MHz, VCC = 2.7 to 5.5 V)
		200 ns (f(XIN) = 5 MHz, VCC = 2.2 to 5.5 V) (N, D version)
	Operating mode	Single-chip
	Address space	1 Mbyte
5	Memory capacity	Refer to Table 1.3 Product Information for R8C/26 Group
Peripheral	Ports	I/O ports: 25 pins, Input port: 3 pins
Functions	LED drive ports	I/O ports: 8 pins (N, D version)
	Timers	Timer RA: 8 bits x 1 channel
		Timer RB: 8 bits x 1 channel
		(Each timer equipped with 8-bit prescaler)
		Timer RC: 16 bits x 1 channel
		(Input capture and output compare circuits)
		Timer RE: With real-time clock and compare match function
		(For J, K version, compare match function only.)
	Serial interfaces	2 channels (UART0, UART1)
		Clock synchronous serial I/O, UART
	Clock synchronous	1 channel
	serial interface	I ² C bus Interface ⁽¹⁾
		Clock synchronous serial I/O with chip select
	LIN module	Hardware LIN: 1 channel (timer RA, UART0)
	A/D converter	10-bit A/D converter: 1 circuit, 12 channels
	Watchdog timer	15 bits x 1 channel (with prescaler)
	Transmission	Start-on-reset selectable
	Interrupts	Internal: 15 sources, External: 4 sources,
		Software: 4 sources, Priority levels: 7 levels
	Clock generation	3 circuits
	circuits	XIN clock generation circuit (with on-chip feedback resistor)
		On-chip oscillator (high speed, low speed)
		High-speed on-chip oscillator has a frequency adjustment function
		XCIN clock generation circuit (32 kHz) (N, D version)
		Real-time clock (timer RE) (N, D version)
	Oscillation-stopped	XIN clock oscillation stop detection function
	detector	7.114 Glock Goomation Gtop actodion function
	Voltage detection	On-chip
	circuit	Off offip
	Power-on reset circuit	On-chip
Electrical	Supply voltage	VCC = 3.0 to 5.5 V (f(XIN) = 20 MHz) (other than K version)
Characteristics	Supply voltage	VCC = 3.0 to 5.5 V (f(XIN) = 20 MHz) (other trial it version)
Characteristics		VCC = 2.7 to 5.5 V (f(XIN) = 10 MHz)
		VCC = 2.2 to 5.5 V (f(XIN) = 10 MHz) (N, D version)
	Current consumption	Typ. 10 mA (VCC = 5.0 V, f(XIN) = 20 MHz)
	(N, D version)	Typ. 6 mA (VCC = 3.0 V , f(XIN) = 20 MHz)
	(IV, D Version)	Typ. 2.0 μ A (VCC = 3.0 V, wait mode (f(XCIN) = 32 kHz)
		Typ. 0.7 μ A (VCC = 3.0 V, wait mode (I(XCIN) = 32 KHz)
Flash Memory	Programming and	VCC = 2.7 to 5.5 V
i idəli ivi c ililliy	erasure voltage	V 00 - 2.7 (0 0.0 V
	Programming and	100 times
		100 tillies
On a ratio a A rate:	erasure endurance	20 to 95°C (N version)
Operating Ambie	int remperature	-20 to 85°C (N version)
		-40 to 85°C (D, J version) ⁽²⁾ , -40 to 125°C (K version) ⁽²⁾
Package		32-pin molded-plastic LQFP

- 1. I²C bus is a trademark of Koninklijke Philips Electronics N. V.
- 2. Specify the D, K version if D, K version functions are to be used.



Table 1.2 Functions and Specifications for R8C/27 Group

	Item	Specification
CPU	Number of fundamental	89 instructions
	instructions	
	Minimum instruction	50 ns (f(XIN) = 20 MHz, VCC = 3.0 to 5.5 V) (other than K version)
	execution time	62.5 ns (f(XIN) = 16 MHz, VCC = 3.0 to 5.5 V) (K version)
		100 ns (f(XIN) = 10 MHz, VCC = 2.7 to 5.5 V)
		200 ns (f(XIN) = 5 MHz, VCC = 2.2 to 5.5 V) (N, D version)
	Operating mode	Single-chip
	Address space	1 Mbyte
	Memory capacity	Refer to Table 1.4 Product Information of R8C/27 Group
Peripheral	Ports	I/O ports: 25 pins, Input port: 3 pins
Functions	LED drive ports	I/O ports: 8 pins (N, D version)
	Timers	Timer RA: 8 bits x 1 channel
		Timer RB: 8 bits x 1 channel
		(Each timer equipped with 8-bit prescaler)
		Timer RC: 16 bits x 1 channel
		(Input capture and output compare circuits)
		Timer RE: With real-time clock and compare match function
		(For J, K version, compare match function only.)
	Serial interfaces	2 channels (UART0, UART1)
		Clock synchronous serial I/O, UART
	Clock synchronous	1 channel
	serial interface	I ² C bus Interface ⁽¹⁾
		Clock synchronous serial I/O with chip select
	LIN module	Hardware LIN: 1 channel (timer RA, UART0)
	A/D converter	10-bit A/D converter: 1 circuit, 12 channels
	Watchdog timer	15 bits x 1 channel (with prescaler)
		Start-on-reset selectable
	Interrupts	Internal: 15 sources, External: 4 sources,
		Software: 4 sources, Priority levels: 7 levels
	Clock generation	3 circuits
	circuits	XIN clock generation circuit (with on-chip feedback resistor)
		On-chip oscillator (high speed, low speed) Llink and an aking a sillator has a frequency adjustment function.
		High-speed on-chip oscillator has a frequency adjustment function
		 XCIN clock generation circuit (32 kHz) (N, D version) Real-time clock (timer RE) (N, D version)
	Oscillation stanced	XIN clock oscillation stop detection function
	Oscillation-stopped detector	And clock oscillation stop detection function
	Voltage detection circuit	On chin
	Power-on reset circuit	On-chip
Electrical	Supply voltage	VCC = 3.0 to 5.5 V (f(XIN) = 20 MHz) (other than K version)
Characteristics	Supply voltage	VCC = 3.0 to 5.5 V (f(XIN) = 26 MHz) (Warsion)
Characteristics		VCC = 2.7 to 5.5 V (f(XIN) = 10 MHz)
		VCC = 2.2 to 5.5 V (f(XIN) = 5 MHz) (N, D version)
	Current consumption	Typ. 10 mA (VCC = 5.0 V, f(XIN) = 20 MHz)
	(N, D version)	Typ. 6 mA (VCC = 3.0 V, f(XIN) = 10 MHz)
	(14, 2 voloion)	Typ. 2.0 μ A (VCC = 3.0 V, wait mode (f(XCIN) = 32 kHz)
		Typ. 0.7 μ A (VCC = 3.0 V, stop mode)
Flash Memory	Programming and	VCC = 2.7 to 5.5 V
	erasure voltage	
	Programming and	10,000 times (data flash)
	erasure endurance	1,000 times (gram ROM)
Operating Ambie		-20 to 85°C (N version)
		-40 to 85°C (D, J version) ⁽²⁾ , -40 to 125°C (K version) ⁽²⁾
Package		32-pin molded-plastic LQFP
i dokay o		02 piii molded-piastic Eq. i

- 1. I^2C bus is a trademark of Koninklijke Philips Electronics N. V.
- 2. Specify the D, K version if D, K version functions are to be used.



1.3 Block Diagram

Figure 1.1 shows a Block Diagram.

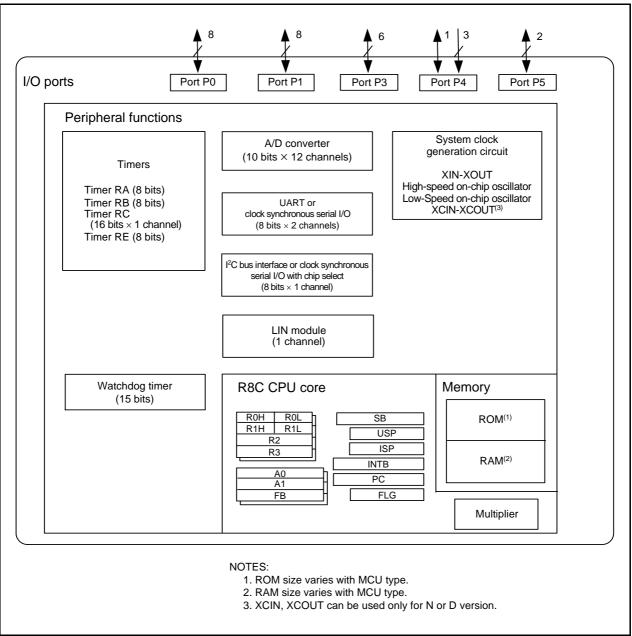


Figure 1.1 Block Diagram

Table 1.4 **Product Information for R8C/27 Group**

Current of Sep. 2008

	ROM (Capacity	RAM			
Part No.	Program ROM	Data flash	Capacity	Package Type	Re	marks
R5F21272SNFP	8 Kbytes	1 Kbyte x 2	512 bytes	PLQP0032GB-A	N version	
R5F21274SNFP	16 Kbytes	1 Kbyte × 2	1 Kbyte	PLQP0032GB-A		
R5F21275SNFP	24 Kbytes	1 Kbyte × 2	1.5 Kbytes	PLQP0032GB-A		
R5F21276SNFP	32 Kbytes	1 Kbyte × 2	1.5 Kbytes	PLQP0032GB-A		
R5F21272SDFP	8 Kbytes	1 Kbyte × 2	512 bytes	PLQP0032GB-A	D version	
R5F21274SDFP	16 Kbytes	1 Kbyte × 2	1 Kbyte	PLQP0032GB-A		
R5F21275SDFP	24 Kbytes	1 Kbyte × 2	1.5 Kbytes	PLQP0032GB-A		
R5F21276SDFP	32 Kbytes	1 Kbyte × 2	1.5 Kbytes	PLQP0032GB-A		
R5F21274JFP	16 Kbytes	1 Kbyte × 2	1 Kbyte	PLQP0032GB-A	J version	
R5F21276JFP	32 Kbytes	1 Kbyte × 2	1.5 Kbytes	PLQP0032GB-A		
R5F21274KFP	16 Kbytes	1 Kbyte × 2	1 Kbyte	PLQP0032GB-A	K version	
R5F21276KFP	32 Kbytes	1 Kbyte × 2	1.5 Kbytes	PLQP0032GB-A		
R5F21272SNXXXFP	8 Kbytes	1 Kbyte × 2	512 bytes	PLQP0032GB-A	N version	Factory
R5F21274SNXXXFP	16 Kbytes	1 Kbyte × 2	1 Kbyte	PLQP0032GB-A		programming
R5F21275SNXXXFP	24 Kbytes	1 Kbyte × 2	1.5 Kbytes	PLQP0032GB-A		product ⁽¹⁾
R5F21276SNXXXFP	32 Kbytes	1 Kbyte × 2	1.5 Kbytes	PLQP0032GB-A		
R5F21272SDXXXFP	8 Kbytes	1 Kbyte × 2	512 bytes	PLQP0032GB-A	D version	
R5F21274SDXXXFP	16 Kbytes	1 Kbyte × 2	1 Kbyte	PLQP0032GB-A		
R5F21275SDXXXFP	24 Kbytes	1 Kbyte × 2	1.5 Kbytes	PLQP0032GB-A		
R5F21276SDXXXFP	32 Kbytes	1 Kbyte × 2	1.5 Kbytes	PLQP0032GB-A		
R5F21274JXXXFP	16 Kbytes	1 Kbyte × 2	1 Kbyte	PLQP0032GB-A	J version	
R5F21276JXXXFP	32 Kbytes	1 Kbyte x 2	1.5 Kbytes	PLQP0032GB-A		
R5F21274KXXXFP	16 Kbytes	1 Kbyte x 2	1 Kbyte	PLQP0032GB-A	K version]
R5F21276KXXXFP	32 Kbytes	1 Kbyte x 2	1.5 Kbytes	PLQP0032GB-A		

^{1.} The user ROM is programmed before shipment.

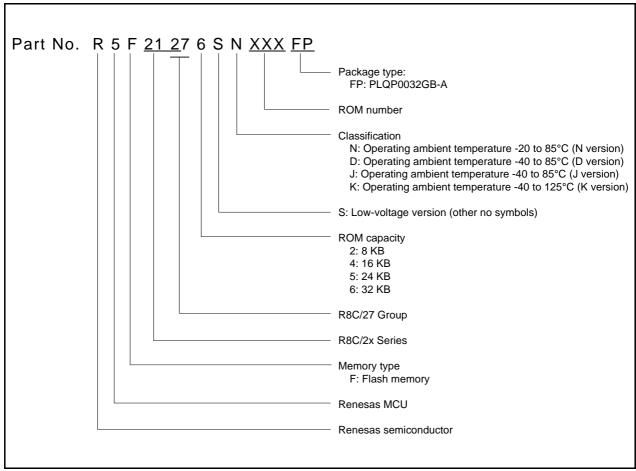


Figure 1.3 Part Number, Memory Size, and Package of R8C/27 Group

2. **Central Processing Unit (CPU)**

Figure 2.1 shows the CPU Registers. The CPU contains 13 registers. R0, R1, R2, R3, A0, A1, and FB configure a register bank. There are two sets of register bank.

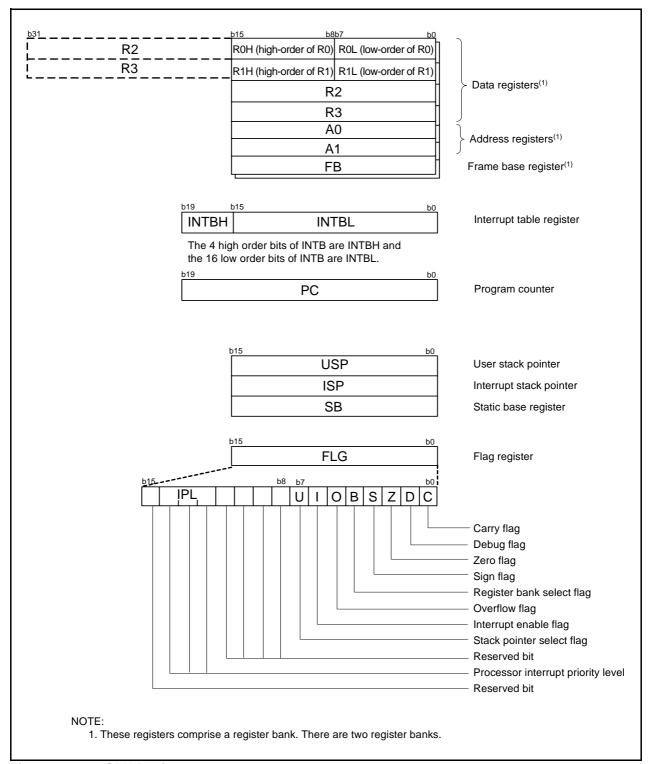


Figure 2.1 **CPU Registers**

Table 4.2 SFR Information (2)⁽¹⁾

Address	Register	Symbol	After reset
0030h	-		
0031h	Voltage Detection Register 1 (2)	VCA1	00001000b
0032h	Voltage Detection Register 2 (2)	VCA2	• N, D version 00h ⁽³⁾
	Tomago Dotosion Hogisto. 2		00100000b ⁽⁴⁾
			• J, K version 00h ⁽⁷⁾
			01000000b ⁽⁸⁾
00001			010000006(0)
0033h			
0034h			
0035h	N 1	1,0046	N. D
0036h	Voltage Monitor 1 Circuit Control Register (5)	VW1C	• N, D version 00001000b
			• J, K version 0000X000b ⁽⁷⁾
			0100X001b ⁽⁸⁾
0037h	Voltage Monitor 2 Circuit Control Register (5)	VW2C	00h
0038h	Voltage Monitor 0 Circuit Control Register (6)	VW0C	0000X000b ⁽³⁾
			0100X001b ⁽⁴⁾
0039h			
	I	L	
003Fh			
0040h			
0041h			
0042h			
0043h			
0044h			
0045h			
0046h			
0047h	Timer RC Interrupt Control Register	TRCIC	XXXXX000b
0047H	Timer No Interrupt Control Negister	TROIC	70000000
0049h			
0043h	Timer RE Interrupt Control Register	TREIC	XXXXX000b
004An	Timer NE Interrupt Control Negister	TREIC	XXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXX
004Bh			
004CH	Key Input Interrupt Control Register	KUPIC	XXXXX000b
004Bh	A/D Conversion Interrupt Control Register	ADIC	XXXXX000b
004En		SSUIC/IICIC	XXXXX000b
	SSU/IIC bus Interrupt Control Register ⁽⁹⁾	33010/11010	**************************************
0050h	LIADTO Too a social latera and Control Descietos	COTIC	VVVVV000b
0051h	UARTO Transmit Interrupt Control Register	SOTIC	XXXXX000b
0052h	UARTO Receive Interrupt Control Register	SORIC	XXXXX000b
0053h	UART1 Transmit Interrupt Control Register	S1TIC	XXXXX000b
0054h	UART1 Receive Interrupt Control Register	S1RIC	XXXXX000b
0055h			Lyana a sa
0056h	Timer RA Interrupt Control Register	TRAIC	XXXXX000b
0057h			
0058h	Timer RB Interrupt Control Register	TRBIC	XXXXX000b
0059h	INT1 Interrupt Control Register	INT1IC	XX00X000b
005Ah	INT3 Interrupt Control Register	INT3IC	XX00X000b
005Bh			
005Ch	I I I I I I I I I I I I I I I I I I I		
005Dh	INT0 Interrupt Control Register	INTOIC	XX00X000b
005Eh			
005Fh			
0060h			
	1		
006Fh			
0070h			
	_		
007Fh			
X: Undefined			

- 1. The blank regions are reserved. Do not access locations in these regions.
- 2. (N, D version) Software reset, watchdog timer reset, voltage monitor 1 reset, or voltage monitor 2 reset do not affect this register. (J, K version) Software reset, watchdog timer reset, or voltage monitor 2 reset do not affect this register.
- 3. The LVD0ON bit in the OFS register is set to 1 and hardware reset.
- 4. Power-on reset, voltage monitor 0 reset or the LVD0ON bit in the OFS register is set to 0, and hardware reset.
- 5. (N, D version) Software reset, watchdog timer reset, voltage monitor 1 reset, or voltage monitor 2 reset do not affect b2 and b3. (J, K version) Software reset, watchdog timer reset, or voltage monitor 2 reset do not affect b2 and b3.
- 6. (N, D version) Software reset, watchdog timer reset, voltage monitor 1 reset, or voltage monitor 2 reset do not affect this register. (J, K version) These regions are reserved. Do not access locations in these regions.
- 7. The LVD1ON bit in the OFS register is set to 1 and hardware reset.
- 8. Power-on reset, voltage monitor 1 reset, or the LVD10N bit in the OFS register is set to 0 and hardware reset.
- 9. Selected by the IICSEL bit in the PMR register.



SFR Information (3)⁽¹⁾ Table 4.3

Address	Register	Symbol	After reset
0080h	1109,500		7
0081h			
0082h			
0083h			
0084h			
0085h			
0086h			
0087h			
0087H			
0089h			
0089h			
008Bh			
008Ch			
008Ch			
008Eh			
008Fh			
0090h			
0090H			
0091h			
0092h 0093h			
0093h 0094h			
0094h 0095h			
0095h			
0097h 0098h			
0098h			
009Ah			
009Bh			
009Ch			
009Dh			
009Eh			
009Fh		LIONED	
00A0h	UARTO Transmit/Receive Mode Register	U0MR	00h
00A1h	UARTO Bit Rate Register	U0BRG	XXh
00A2h	UART0 Transmit Buffer Register	U0TB	XXh
00A3h	LIANTO T	11000	XXh
00A4h	UART0 Transmit/Receive Control Register 0	U0C0	00001000b
00A5h	UART0 Transmit/Receive Control Register 1	U0C1	00000010b
00A6h	UART0 Receive Buffer Register	U0RB	XXh
00A7h			XXh
00A8h	UART1 Transmit/Receive Mode Register	U1MR	00h
00A9h	UART1 Bit Rate Register	U1BRG	XXh
00AAh	UART1 Transmit Buffer Register	U1TB	XXh
00ABh			XXh
00ACh	UART1 Transmit/Receive Control Register 0	U1C0	00001000b
00ADh	UART1 Transmit/Receive Control Register 1	U1C1	00000010b
00AEh	UART1 Receive Buffer Register	U1RB	XXh
00AFh			XXh
00B0h			1
00B1h			
00B2h			1
00B3h			
00B4h			
00B5h			
00B6h			
00B7h			
00B8h	SS Control Register H / IIC bus Control Register 1 ⁽²⁾	SSCRH / ICCR1	00h
00B9h	SS Control Register L / IIC bus Control Register 2 ⁽²⁾	SSCRL / ICCR2	01111101b
00BAh	SS Mode Register / IIC bus Mode Register ⁽²⁾	SSMR / ICMR	00011000b
00BBh	SS Enable Register / IIC bus Interrupt Enable Register ⁽²⁾	SSER / ICIER	00h
00BCh	SS Status Register / IIC bus Status Register ⁽²⁾	SSSR / ICSR	00h / 0000X000b
00BDh	SS Mode Register 2 / Slave Address Register ⁽²⁾	SSMR2 / SAR	00h
00BEh		SSTDR / ICDRT	FFh
	SS Transmit Data Register / IIC bus Transmit Data Register(2)		
00BFh X: Undefined	SS Receive Data Register / IIC bus Receive Data Register ⁽²⁾	SSRDR / ICDRR	FFh

X: Undefined

NOTES:

1. The blank regions are reserved. Do not access locations in these regions.
2. Selected by the IICSEL bit in the PMR register.

Table 4.5 SFR Information (5)⁽¹⁾

Address	Register	Symbol	After reset
0100h	Timer RA Control Register	TRACR	00h
0101h	Timer RA I/O Control Register	TRAIOC	00h
0102h	Timer RA Mode Register	TRAMR	00h
0103h	Timer RA Prescaler Register	TRAPRE	FFh
0104h	Timer RA Register	TRA	FFh
0105h			
0106h	LIN Control Register	LINCR	00h
0107h	LIN Status Register	LINST	00h
0108h	Timer RB Control Register	TRBCR	00h
0109h	Timer RB One-Shot Control Register	TRBOCR	00h
010Ah	Timer RB I/O Control Register	TRBIOC	00h
010Bh	Timer RB Mode Register	TRBMR	00h
010Ch	Timer RB Prescaler Register	TRBPRE	FFh
010Dh	Timer RB Secondary Register	TRBSC	FFh
010Eh	Timer RB Primary Register	TRBPR	FFh
010Fh			
0110h			
0111h			
0112h			
0113h			
0114h			
0115h			
0116h			
0117h			
011711 0118h	Timer RE Second Data Register / Counter Data Register	TRESEC	00h
0119h	Timer RE Minute Data Register / Compare Data Register	TREMIN	00h
0119H		TREHR	00h
	Timer RE Hour Data Register ⁽²⁾		
011Bh	Timer RE Day of Week Data Register ⁽²⁾	TREWK	00h
011Ch	Timer RE Control Register 1	TRECR1	00h
011Dh	Timer RE Control Register 2	TRECR2	00h
011Eh	Timer RE Count Source Select Register	TRECSR	00001000b
011Fh			
0120h	Timer RC Mode Register	TRCMR	01001000b
0121h	Timer RC Control Register 1	TRCCR1	00h
0122h	Timer RC Interrupt Enable Register	TRCIER	01110000b
0123h	Timer RC Status Register	TRCSR	01110000b
0124h	Timer RC I/O Control Register 0	TRCIOR0	10001000b
0125h	Timer RC I/O Control Register 1	TRCIOR1	10001000b
0126h	Timer RC Counter	TRC	00h
0127h			00h
0128h	Timer RC General Register A	TRCGRA	FFh
0129h			FFh
012Ah	Timer RC General Register B	TRCGRB	FFh
012Bh			FFh
012Ch	Timer RC General Register C	TRCGRC	FFh
012Dh	-		FFh
012Eh	Timer RC General Register D	TRCGRD	FFh
012Fh	-		FFh
	Timer RC Control Register 2	TRCCR2	00011111b
0131h	Timer RC Digital Filter Function Select Register	TRCDF	00h
0132h	Timer RC Output Master Enable Register	TRCOER	01111111b
0133h	·		
0134h			
0135h			
0136h			
0137h			
0138h			
0139h			
0139h			
013An			
013Ch			
013Dh			
013Dh			
013Fh			

- The blank regions are reserved. Do not access locations in these regions.
 In J, K version these regions are reserved. Do not access locations in these regions.

Electrical Characteristics 5.

N, D Version 5.1

Table 5.1 **Absolute Maximum Ratings**

Symbol	Parameter	Condition	Rated Value	Unit
Vcc/AVcc	Supply voltage		-0.3 to 6.5	V
Vı	Input voltage		-0.3 to Vcc + 0.3	V
Vo	Output voltage		-0.3 to Vcc + 0.3	V
Pd	Power dissipation	Topr = 25°C	500	mW
Topr	Operating ambient temperature		-20 to 85 (N version) / -40 to 85 (D version)	°C
Tstg	Storage temperature		-65 to 150	°C

Table 5.2 **Recommended Operating Conditions**

0	_	D	0 177		Standard		11.2
Symbol	F	Parameter	Conditions	Min.	Тур.	Max.	Unit
Vcc/AVcc	Supply voltage			2.2	_	5.5	V
Vss/AVss	Supply voltage			_	0	_	V
VIH	Input "H" voltage			0.8 Vcc	-	Vcc	V
VIL	Input "L" voltage			0	_	0.2 Vcc	V
IOH(sum)	Peak sum output "H" current	Sum of all pins IOH(peak)		-	_	-160	mA
IOH(sum)	Average sum output "H" current	Sum of all pins IOH(avg)		-	-	-80	mA
IOH(peak)	Peak output "H"	Except P1_0 to P1_7		-	_	-10	mA
	current	P1_0 to P1_7		-	=	-40	mA
IOH(avg)	Average output	Except P1_0 to P1_7		-	=	-5	mA
	"H" current	P1_0 to P1_7		-	-	-20	mA
IOL(sum)	Peak sum output "L" currents	Sum of all pins IOL(peak)		-	_	160	mA
IOL(sum)	Average sum output "L" currents	Sum of all pins IOL(avg)		-	_	80	mA
IOL(peak)	Peak output "L"	Except P1_0 to P1_7		_	_	10	mA
	currents	P1_0 to P1_7		_	_	40	mA
IOL(avg)	Average output	Except P1_0 to P1_7		-	-	5	mA
	"L" current	P1_0 to P1_7		_	_	20	mA
f(XIN)	XIN clock input osc	illation frequency	3.0 V ≤ Vcc ≤ 5.5 V	0	-	20	MHz
			2.7 V ≤ Vcc < 3.0 V	0	=	10	MHz
			2.2 V ≤ Vcc < 2.7 V	0	-	5	MHz
f(XCIN)	XCIN clock input of	scillation frequency	2.2 V ≤ Vcc ≤ 5.5 V	0	-	70	kHz
_	System clock	OCD2 = 0	3.0 V ≤ Vcc ≤ 5.5 V	0	-	20	MHz
		XIN clock selected	2.7 V ≤ Vcc < 3.0 V	0	_	10	MHz
			2.2 V ≤ Vcc < 2.7 V	0	_	5	MHz
		OCD2 = 1 On-chip oscillator clock selected	FRA01 = 0 Low-speed on-chip oscillator clock selected	=	125	-	kHz
			FRA01 = 1 High-speed on-chip oscillator clock selected 3.0 V ≤ Vcc ≤ 5.5 V	=	-	20	MHz
			FRA01 = 1 High-speed on-chip oscillator clock selected 2.7 V ≤ Vcc ≤ 5.5 V	_	-	10	MHz
NOTES:			FRA01 = 1 High-speed on-chip oscillator clock selected 2.2 V ≤ Vcc ≤ 5.5 V	_	-	5	MHz

^{2.} The average output current indicates the average value of current measured during 100 ms.



^{1.} Vcc = 2.2 to 5.5 V at $T_{opr} = -20$ to $85^{\circ}C$ (N version) / -40 to $85^{\circ}C$ (D version), unless otherwise specified.

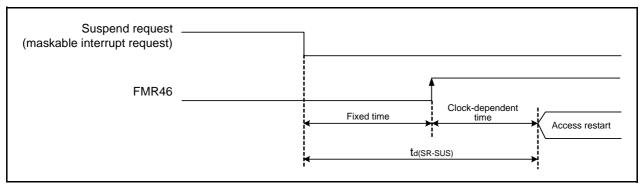


Figure 5.2 Time delay until Suspend

Table 5.6 **Voltage Detection 0 Circuit Electrical Characteristics**

Symbol	Parameter	Condition	Standard			Unit
Syllibol	Falametei	Condition	Min.	Тур.	Max.	Offic
Vdet0	Voltage detection level		2.2	2.3	2.4	V
=	Voltage detection circuit self power consumption	VCA25 = 1, Vcc = 5.0 V	_	0.9	-	μΑ
td(E-A)	Waiting time until voltage detection circuit operation starts ⁽²⁾		-	=	300	μS
Vccmin	MCU operating voltage minimum value		2.2	=	-	V

- 1. The measurement condition is Vcc = 2.2 to 5.5 V and Topr = -20 to 85°C (N version) / -40 to 85°C (D version).
- 2. Necessary time until the voltage detection circuit operates when setting to 1 again after setting the VCA25 bit in the VCA2 register to 0.

Table 5.7 **Voltage Detection 1 Circuit Electrical Characteristics**

Symbol	Parameter	Condition	Standard			Unit
Syllibol	Farameter	Condition	Min.	Тур.	Max.	Offic
Vdet1	Voltage detection level ⁽⁴⁾		2.70	2.85	3.00	V
-	Voltage monitor 1 interrupt request generation time ⁽²⁾		_	40	_	μS
=	Voltage detection circuit self power consumption	VCA26 = 1, Vcc = 5.0 V	-	0.6	-	μΑ
td(E-A)	Waiting time until voltage detection circuit operation starts ⁽³⁾		=	=	100	μS

- 1. The measurement condition is Vcc = 2.2 to 5.5 V and Topr = -20 to 85°C (N version) / -40 to 85°C (D version).
- 2. Time until the voltage monitor 1 interrupt request is generated after the voltage passes Vdet1.
- 3. Necessary time until the voltage detection circuit operates when setting to 1 again after setting the VCA26 bit in the VCA2 register to 0.
- 4. This parameter shows the voltage detection level when the power supply drops. The voltage detection level when the power supply rises is higher than the voltage detection level when the power supply drops by approximately 0.1 V.

Table 5.8 **Voltage Detection 2 Circuit Electrical Characteristics**

Symbol	Parameter	Condition		Unit		
Syllibol	Farameter	Condition	Min.	Тур.	Max.	Offic
Vdet2	Voltage detection level		3.3	3.6	3.9	V
-	Voltage monitor 2 interrupt request generation time ⁽²⁾		_	40	_	μS
=	Voltage detection circuit self power consumption	VCA27 = 1, Vcc = 5.0 V	-	0.6	-	μΑ
td(E-A)	Waiting time until voltage detection circuit operation starts ⁽³⁾		-	=	100	μ\$

- 1. The measurement condition is Vcc = 2.2 to 5.5 V and Topr = -20 to 85°C (N version) / -40 to 85°C (D version).
- $2. \ \ \text{Time until the voltage monitor 2 interrupt request is generated after the voltage passes V_{det2}.}$
- 3. Necessary time until the voltage detection circuit operates after setting to 1 again after setting the VCA27 bit in the VCA2 register to 0.



Table 5.15 Electrical Characteristics (1) [Vcc = 5 V]

Symbol	Po	rameter	Condition	-n	S	tandard		Unit
Symbol	Pai	rameter	Condition	Condition		Тур.	Max.	Unit
Vон	Output "H" voltage	Except P1_0 to P1_7,	IOH = -5 mA		Vcc - 2.0	_	Vcc	V
		XOUT	IOH = -200 μA		Vcc - 0.5	_	Vcc	V
		P1_0 to P1_7	Drive capacity HIGH	Iон = -20 mA	Vcc - 2.0	_	Vcc	V
			Drive capacity LOW	Iон = -5 mA	Vcc - 2.0	_	Vcc	V
		XOUT	Drive capacity HIGH	Iон = -1 mA	Vcc - 2.0	_	Vcc	V
			Drive capacity LOW	Ιοн = -500 μΑ	Vcc - 2.0	_	Vcc	V
Vol	Output "L" voltage	Except P1_0 to P1_7,	IoL = 5 mA		_	_	2.0	V
		XOUT	IoL = 200 μA		_	_	0.45	V
		P1_0 to P1_7	Drive capacity HIGH	IoL = 20 mA	_	_	2.0	V
			Drive capacity LOW	IoL = 5 mA	_	_	2.0	V
		XOUT	Drive capacity HIGH	IoL = 1 mA	_	_	2.0	V
			Drive capacity LOW	IOL = 500 μA	_	_	2.0	V
VT+-VT-	Hysteresis	INTO, INT1, INT3, KIO, KI1, KI2, KI3, TRAIO, RXDO, RXD1, CLK0, CLK1, SSI, SCL, SDA, SSO			0.1	0.5	-	V
		RESET			0.1	1.0	-	V
Іін	Input "H" current		VI = 5 V, Vcc = 5 V		-	-	5.0	μА
lıL	Input "L" current		VI = 0 V, Vcc = 5 V		-	-	-5.0	μА
RPULLUP	Pull-up resistance		VI = 0 V, Vcc = 5 V		30	50	167	kΩ
RfXIN	Feedback resistance	XIN			-	1.0	-	ΜΩ
RfXCIN	Feedback resistance	XCIN			-	18	-	МΩ
VRAM	RAM hold voltage		During stop mode		1.8	-	-	V

^{1.} Vcc = 4.2 to 5.5 V at Topr = -20 to $85^{\circ}C$ (N version) / -40 to $85^{\circ}C$ (D version), f(XIN) = 20 MHz, unless otherwise specified.

Table 5.16 Electrical Characteristics (2) [Vcc = 5 V] (Topr = -20 to 85°C (N version) / -40 to 85°C (D version), unless otherwise specified.)

Symbol	Parameter	Condition		Standard			Unit
Syllibol	Faiametei		Condition	Min. Typ.		Max.	Offic
Icc	Power supply current (Vcc = 3.3 to 5.5 V) Single-chip mode, output pins are open,	High-speed clock mode	XIN = 20 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division	ı	10	17	mA
	other pins are Vss		XIN = 16 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division	-	9	15	mA
			XIN = 10 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division	I	6	_	mA
			XIN = 20 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8	-	5	_	mA
			XIN = 16 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8	-	4	-	mA
			XIN = 10 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8	-	2.5	-	mA
		High-speed on-chip oscillator mode	XIN clock off High-speed on-chip oscillator on fOCO = 20 MHz Low-speed on-chip oscillator on = 125 kHz No division	-	10	15	mA
			XIN clock off High-speed on-chip oscillator on fOCO = 20 MHz Low-speed on-chip oscillator on = 125 kHz Divide-by-8	-	4	_	mA
			XIN clock off High-speed on-chip oscillator on fOCO = 10 MHz Low-speed on-chip oscillator on = 125 kHz No division	I	5.5	10	mA
			XIN clock off High-speed on-chip oscillator on fOCO = 10 MHz Low-speed on-chip oscillator on = 125 kHz Divide-by-8	I	2.5	=	mA
		Low-speed on-chip oscillator mode	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8, FMR47 = 1	I	130	300	μА
		Low-speed clock mode	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off XCIN clock oscillator on = 32 kHz FMR47 = 1	I	130	300	μА
			XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off XCIN clock oscillator on = 32 kHz Program operation on RAM Flash memory off, FMSTP = 1	_	30	_	μА

Table 5.22 Electrical Characteristics (3) [Vcc = 3 V]

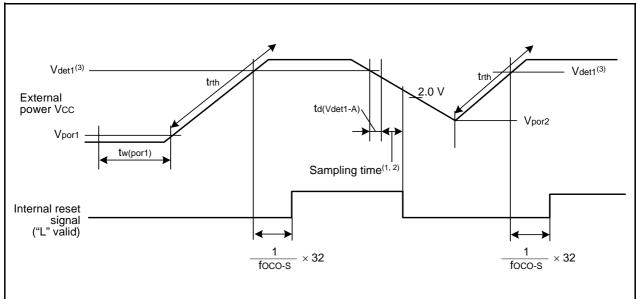
Symbol	Parameter		Condition		Standard			Unit
Symbol	Fala	imeter	Conc	altion	Min.	Тур.	Max.	Offic
Vон	Output "H" voltage	Except P1_0 to P1_7, XOUT	Iон = -1 mA		Vcc - 0.5	_	Vcc	V
		P1_0 to P1_7	Drive capacity HIGH	Iон = -5 mA	Vcc - 0.5	-	Vcc	V
			Drive capacity LOW	Iон = -1 mA	Vcc - 0.5	=	Vcc	V
		XOUT	Drive capacity HIGH	Iон = -0.1 mA	Vcc - 0.5	-	Vcc	V
			Drive capacity LOW	Іон = -50 μΑ	Vcc - 0.5	-	Vcc	V
Vol	Output "L" voltage	Except P1_0 to P1_7, XOUT	IoL = 1 mA		-	_	0.5	V
		P1_0 to P1_7	Drive capacity HIGH	IoL = 5 mA	-	-	0.5	V
			Drive capacity LOW	IoL = 1 mA	-	_	0.5	V
		XOUT	Drive capacity HIGH	IOL = 0.1 mA	-	_	0.5	V
			Drive capacity LOW	IOL = 50 μA	-	-	0.5	V
VT+-VT-	Hysteresis	NT0, INT1, INT3, KI0, KI1, KI2, KI3, TRAIO, RXD0, RXD1, CLK0, CLK1, SSI, SCL, SDA, SSO			0.1	0.3	=	V
		RESET			0.1	0.4	-	V
Іін	Input "H" current	I	VI = 3 V, Vcc = 3	3 V	=	_	4.0	μΑ
lıL	Input "L" current		VI = 0 V, Vcc = 3 V		_	_	-4.0	μА
RPULLUP	Pull-up resistance	esistance $VI = 0 V, Vcc = 3 V$		3 V	66	160	500	kΩ
RfXIN	Feedback resistance	XIN			-	3.0	-	МΩ
RfXCIN	Feedback resistance	XCIN			=	18	=	МΩ
VRAM	RAM hold voltage		During stop mode	е	1.8	_	-	V

^{1.} Vcc = 2.7 to 3.3 V at Topr = -20 to 85°C (N version) / -40 to 85°C (D version), f(XIN) = 10 MHz, unless otherwise specified.

Table 5.41 Power-or	Reset Circuit.	Voltage Monitor	1 Reset Electrical	Characteristics ⁽³⁾
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Symbol	Parameter	Condition		Unit		
Symbol	Faranielei	Condition	Min.	Тур.	Max.	Offic
Vpor1	Power-on reset valid voltage ⁽⁴⁾		_	-	0.1	V
Vpor2	Power-on reset or voltage monitor 1 reset valid voltage		0	_	Vdet1	V
trth	External power Vcc rise gradient	Vcc ≤ 3.6 V	20(2)	-	_	mV/msec
		Vcc > 3.6 V	20(2)	=	2,000	mV/msec

- 1. The measurement condition is Topr = -40 to 85°C (J version) / -40 to 125°C (K version), unless otherwise specified.
- 2. This condition (the minimum value of external power Vcc rise gradient) does not apply if $V_{por2} \ge 1.0 \text{ V}$.
- 3. To use the power-on reset function, enable voltage monitor 1 reset by setting the LVD1ON bit in the OFS register to 0, the VW1C0 and VW1C6 bits in the VW1C register to 1 respectively, and the VCA26 bit in the VCA2 register to 1.
- 4. tw(por1) indicates the duration the external power Vcc must be held below the effective voltage (Vpor1) to enable a power on reset. When turning on the power for the first time, maintain tw(por1) for 30 s or more if -20°C ≤ Topr ≤ 125°C, maintain tw(por1) for 3,000 s or more if -40°C ≤ Topr < -20°C.</p>



- 1. When using the voltage monitor 1 digital filter, ensure VCC is $2.0\ V$ or higher during the sampling time.
- 2. The sampling clock can be selected. Refer to 6. Voltage Detection Circuit of Hardware Manual for details.
- 3. Vdet1 indicates the voltage detection level of the voltage detection 1 circuit. Refer to 6. Voltage Detection Circuit of Hardware Manual for details.

Figure 5.22 Reset Circuit Electrical Characteristics

Table 5.42 High-speed On-Chip Oscillator Circuit Electrical Characteristics

Symbol	Parameter	Condition		Unit		
Syllibol	Farameter	Condition	Min.	Тур.	Max. 40.8 41.2 41.6 42 42.4 F7h	Offic
fOCO40M	High-speed on-chip oscillator frequency temperature · supply voltage dependence	Vcc = 4.75 to 5.25 V $0^{\circ}C \leq Topr \leq 60^{\circ}C^{(2)}$	39.2	40	40.8	MHz
		Vcc = 3.0 to 5.5 V -20°C \leq Topr \leq 85°C ⁽²⁾	38.8	40	41.2	MHz
		Vcc = 3.0 to 5.5 V -40°C \leq Topr \leq 85°C ⁽²⁾	38.4	40	41.6	MHz
		Vcc = 3.0 to 5.5 V -40°C \leq Topr \leq 125°C ⁽²⁾	38	40	42	MHz
		Vcc = 2.7 to 5.5 V -40°C \leq Topr \leq 125°C(2)	37.6	40	42.4	MHz
_	Value in FRA1 register after reset		08h	-	F7h	_
=	Oscillation frequency adjustment unit of high- speed on-chip oscillator	Adjust FRA1 register (value after reset) to -1	=	+0.3	=	MHz
_	Oscillation stability time		-	10	100	μS
_	Self power consumption at oscillation	Vcc = 5.0 V, Topr = 25°C	-	400	-	μΑ

- 1. Vcc = 2.7 to 5.5 V, Topr = -40 to $85^{\circ}C$ (J version) / -40 to $125^{\circ}C$ (K version), unless otherwise specified.
- 2. These standard values show when the FRA1 register value after reset is assumed.

Table 5.43 Low-speed On-Chip Oscillator Circuit Electrical Characteristics

Symbol	Parameter	Condition		Unit		
Symbol	Falametei	Condition	Min.	Тур.	Max.	Offic
fOCO-S	Low-speed on-chip oscillator frequency		40	125	250	kHz
_	Oscillation stability time		-	10	100	μS
_	Self power consumption at oscillation	Vcc = 5.0 V, Topr = 25°C	_	15	_	μА

NOTE:

Table 5.44 Power Supply Circuit Timing Characteristics

Svmbol	Parameter	Condition	Standard			Unit
Symbol	Falametei	Condition	Min.	Тур.	Max.	Offic
td(P-R)	Time for internal power supply stabilization during power-on ⁽²⁾		1	=	2000	μS
td(R-S)	STOP exit time ⁽³⁾		-	-	150	μS

- 1. The measurement condition is Vcc = 2.7 to 5.5 V and T_{opr} = 25°C.
- 2. Waiting time until the internal power supply generation circuit stabilizes during power-on.
- 3. Time until system clock supply starts after the interrupt is acknowledged to exit stop mode.

^{1.} Vcc = 2.7 to 5.5 V, Topr = -40 to 85°C (J version) / -40 to 125°C (K version), unless otherwise specified.

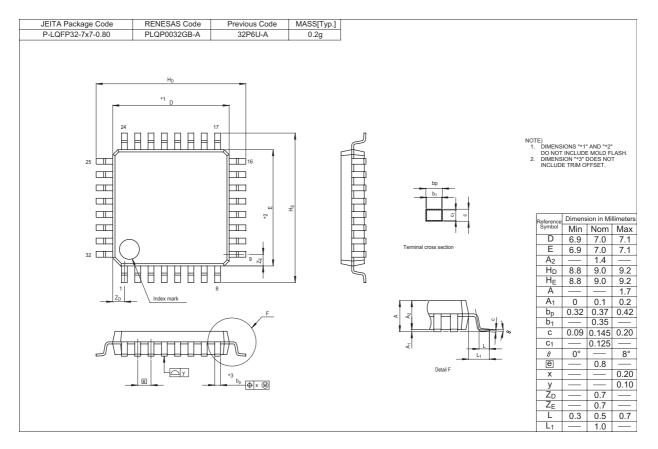
Table 5.53 Electrical Characteristics (3) [Vcc = 3 V]

Symbol	Pare	ameter	Condi	ition	Standard			Unit
Symbol	Faic	ameter	Condition		Min.	Тур.	Max.	Offic
Vон	Output "H" voltage	Except XOUT	Iон = -1 mA		Vcc - 0.5	-	Vcc	V
		XOUT	Drive capacity HIGH	Iон = -0.1 mA	Vcc - 0.5	_	Vcc	V
			Drive capacity LOW	Іон = -50 μΑ	Vcc - 0.5	=	Vcc	V
Vol	Output "L" voltage	Except XOUT	IoL = 1 mA		_	-	0.5	V
		XOUT	Drive capacity HIGH	IOL = 0.1 mA	=	=	0.5	V
			Drive capacity LOW	IOL = 50 μA	=	=	0.5	V
VT+-VT-	Hysteresis	INTO, INT1, INT3, KIO, KI1, KI2, KI3, TRAIO, RXDO, RXD1, CLKO,CLK1, SSI, SCL, SDA, SSO			0.1	0.3	-	V
		RESET			0.1	0.4	_	V
Іін	Input "H" current	1	VI = 3 V, Vcc = 3	V	_	-	4.0	μΑ
lıL	Input "L" current		VI = 0 V, Vcc = 3'	V	_	-	-4.0	μΑ
RPULLUP	Pull-up resistance		VI = 0 V, Vcc = 3V		66	160	500	kΩ
RfXIN	Feedback resistance	XIN			-	3.0	_	ΜΩ
VRAM	RAM hold voltage	•	During stop mode	Э	2.0	_	-	V

^{1.} Vcc = 2.7 to 3.3 V at Topr = -40 to 85°C (J version) / -40 to 125°C (K version), f(XIN) = 10 MHz, unless otherwise specified.

Package Dimensions

Diagrams showing the latest package dimensions and mounting information are available in the "Packages" section of the Renesas Technology website.



REVISION HISTORY

R8C/26 Group, R8C/27 Group Datasheet

	5.4		Description
Rev.	Date	Page	Summary
0.10	Nov 14, 2005	-	First edition issued
0.20	Feb 06, 2006	2, 3	Table 1.1 Functions and Specifications for R8C/26Group and Table 1.2 Functions and Specifications for R8C/27 Group; Minimum instruction execution time and Supply voltage revised
		9	Table 1.6 Pin Name Information by Pin Number; "XOUT" \rightarrow "XOUT/XCOUT" and "XIN" \rightarrow "XIN/XCIN" revised
		18	Table 4.4 SFR Information (4); 00FEh: "DRR" → "P1DRR" revised
		19	Table 4.5 SFR Information (5); -0119h: "Timer RE Minute Data Register / Compare Register" → "Timer RE Minute Data Register / Compare Data Register" -011Ah: "Timer RE Time Data Register" → "Timer RE Hour Data Register" -011Bh: "Timer RE Day Data Register" → "Timer RE Day of Week Data Register" revised
		22 to 45	5. Electrical Characteristics added
1.00	Nov 08, 2006	All pages	"Preliminary" deleted
		2	Table 1.1 revised
		3	Table 1.2 revised
		4	Figure 1.1 revised
		5	Table 1.3 revised
		6	Table 1.4 revised
		7	Figure 1.4 revised
		9	Table 1.6 revised
		15	Table 4.1;
			 • 001Ch: "00h" → "00h, 10000000b" revised • 000Fh: "000XXXXXb" → "00X11111b" revised • 0029h: "High-Speed On-Chip Oscillator Control Register 4, FRA4, When shipping" added • 002Bh: "High-Speed On-Chip Oscillator Control Register 6, FRA6, When shipping" added • 0032h: "00h, 01000000b" → "00h, 00100000b" revised • 0038h: "00001000b, 01001001b" → "0000X000b, 0100X001b" revised • NOTE3 and 4 revised; NOTE6 added
		18	Table 4.4; • 00E0h, 00E1h, 00E5h, 00E8h, 00E9h: "XXh" → "00h" revised • 00FDh: "XX00000000b" → "00h" revised
		22	Table 5.2 revised
		23	Figure 5.1 title revised
		24	Table 5.4 revised
		25	Table 5.5 revised
		26	Figure 5.2 title revised and Table 5.7 NOTE4 added

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